

# ***Direct Electron Detectors and their Application in (Scanning) Transmission Electron Microscopy***

**Paul J. M. Smeets**

*Research Assistant Professor*

*EPIC Facility Manager FIB/TEM*



# Overview

- What is a Direct Electron Detector (DED)?
- Overview of DEDs in EPIC-TEM Facility
- Advantages for (S)TEM Applications

# Features of the Ideal Detector for (S)TEM

- Respond to every electron (Quantum efficiency)
- Does not respond where the electrons are not (Low Noise)
- Know the position of these electrons (Spatial Resolution)
- Knows when the electron was detected (Temporal Resolution)
- Knows how many electrons arrived (Linearity / Dynamic Range)
- Energy of every electron
- Momentum of every electron
- Spin of electron
- ...

**Detector Quantum Efficiency (DQE (f))**

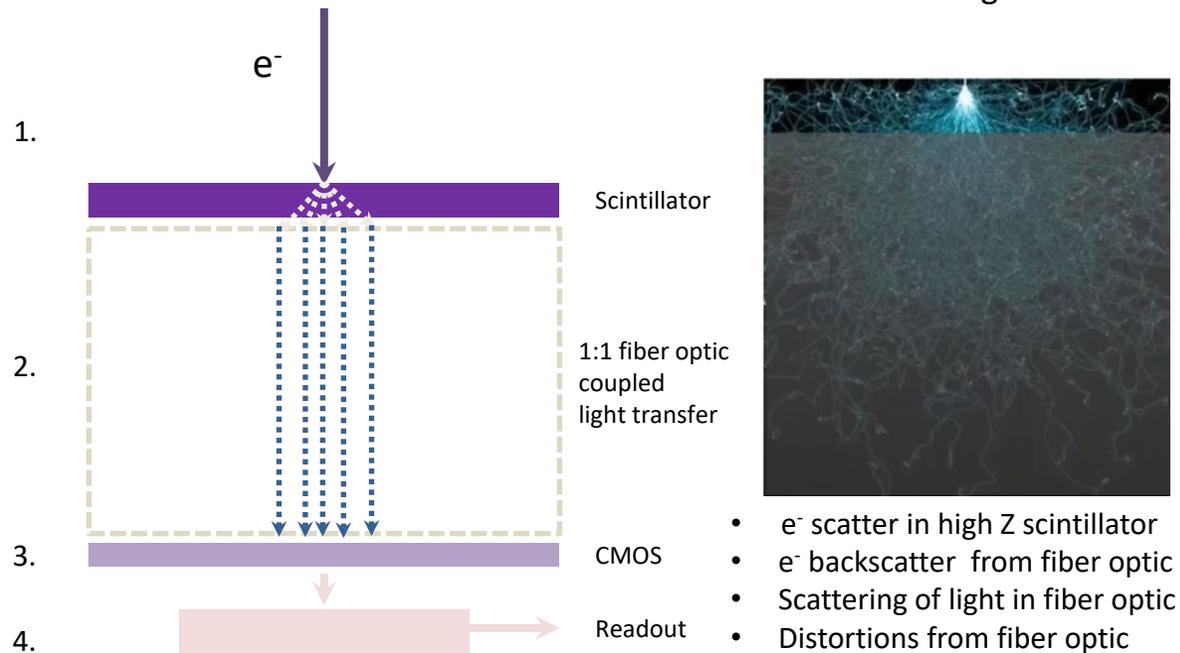
$$DQE(s) = \frac{SNR_{out}(s)}{SNR_{in}(s)}$$

# Traditional vs. Direct Electron Detection (DED) Camera

## Traditional scintillator camera (CCD or CMOS)

**Traditional cameras** use a **scintillator** to generate light that is transferred to a sensor and detected

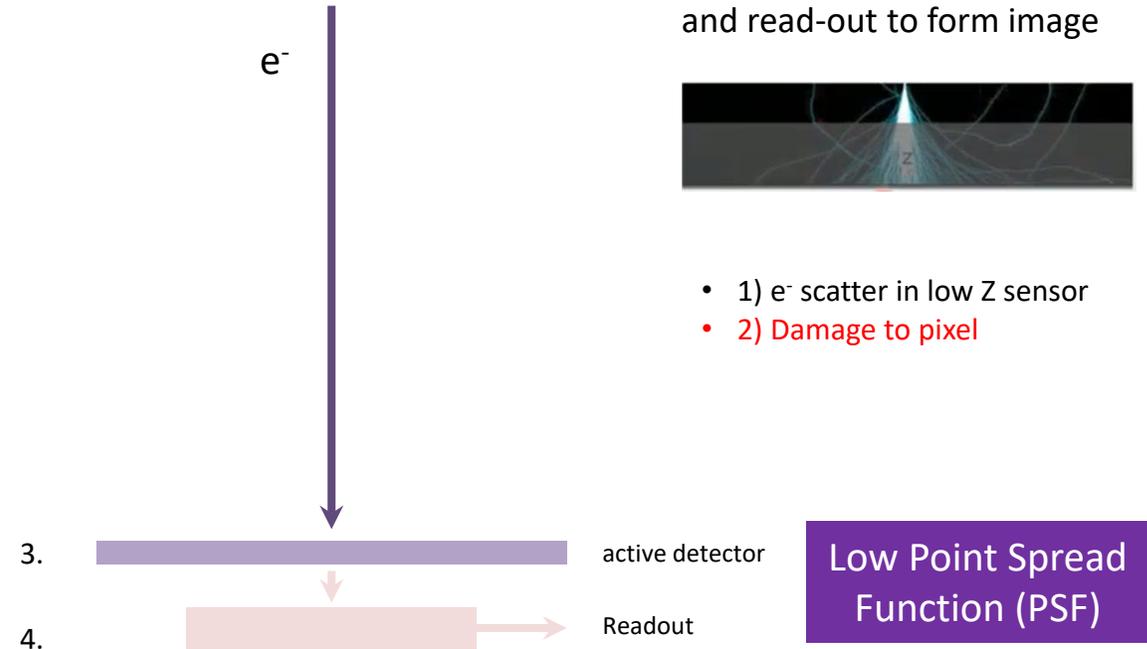
1. Convert electrons to light
2. Transfer light
3. Detect light and convert to signal
4. Electronically transfer signal and read-out to form image



## Monolithic Direct Electron Detection camera

**Direct detection** refers to using a detector which is directly exposed to the  $e^-$  beam to create a signal

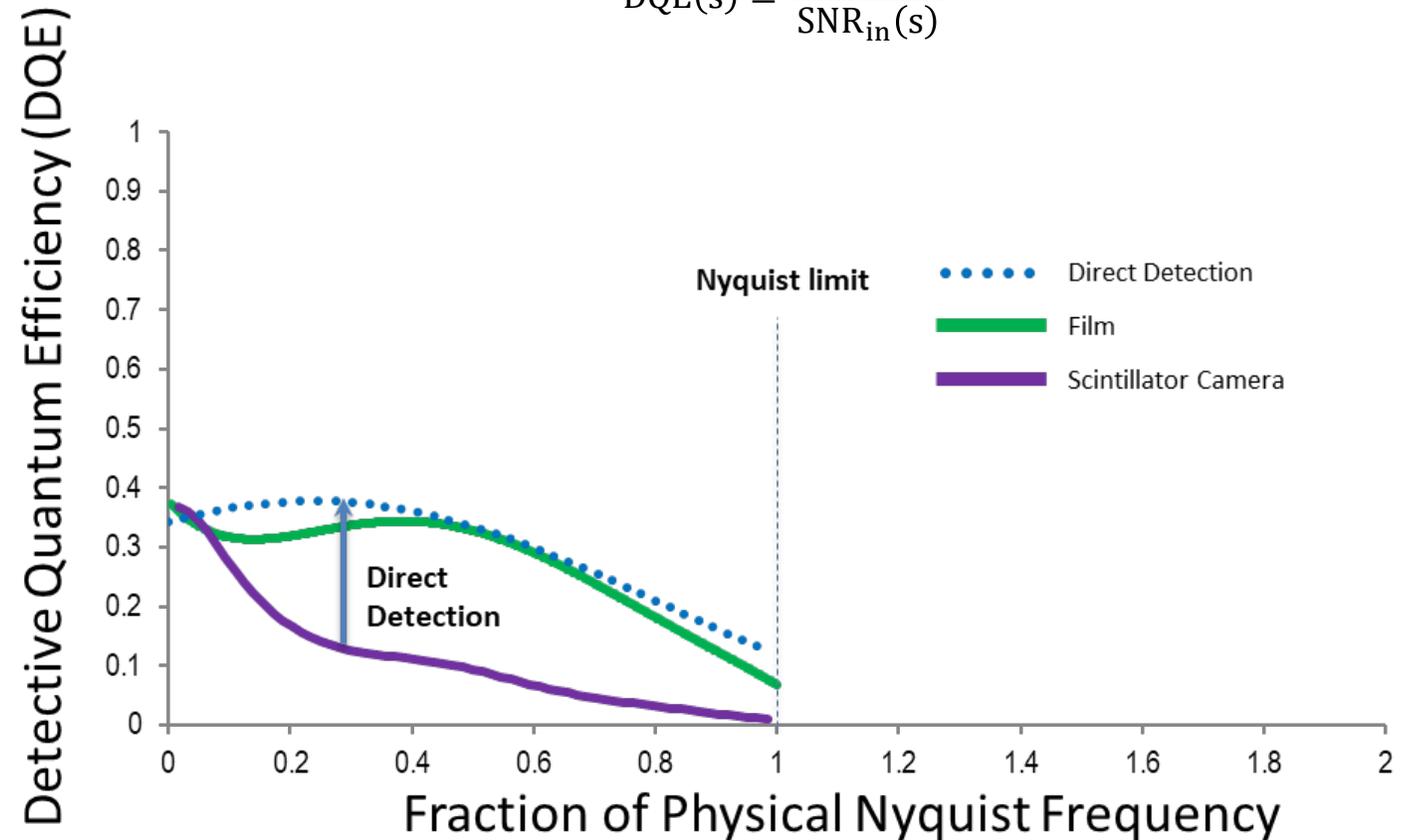
1. Convert electrons to light
2. Transfer light
3. Detect **electrons** and convert to signal
4. Electronically transfer signal and read-out to form image



# Performance of Traditional vs. DED Camera

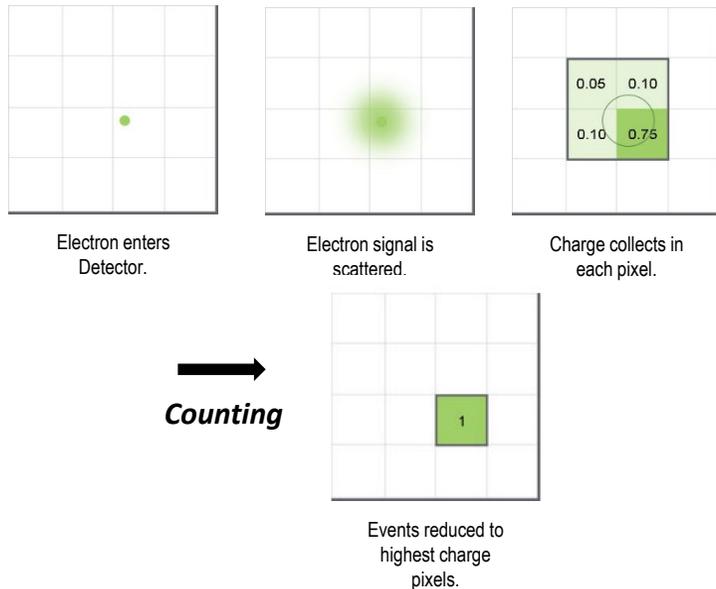
- **DQE** is a function of sampling frequency, and is amongst others dependent on dose rate and accelerating voltage
- Nyquist frequency defines the max. spatial frequency (or minimal resolution) that can be measured by a detector. Minimal resolution =  $2 \times$  pixel size
- **For a perfect detector, DQE = 1** for all spatial frequencies

$$DQE(s) = \frac{SNR_{out}(s)}{SNR_{in}(s)}$$

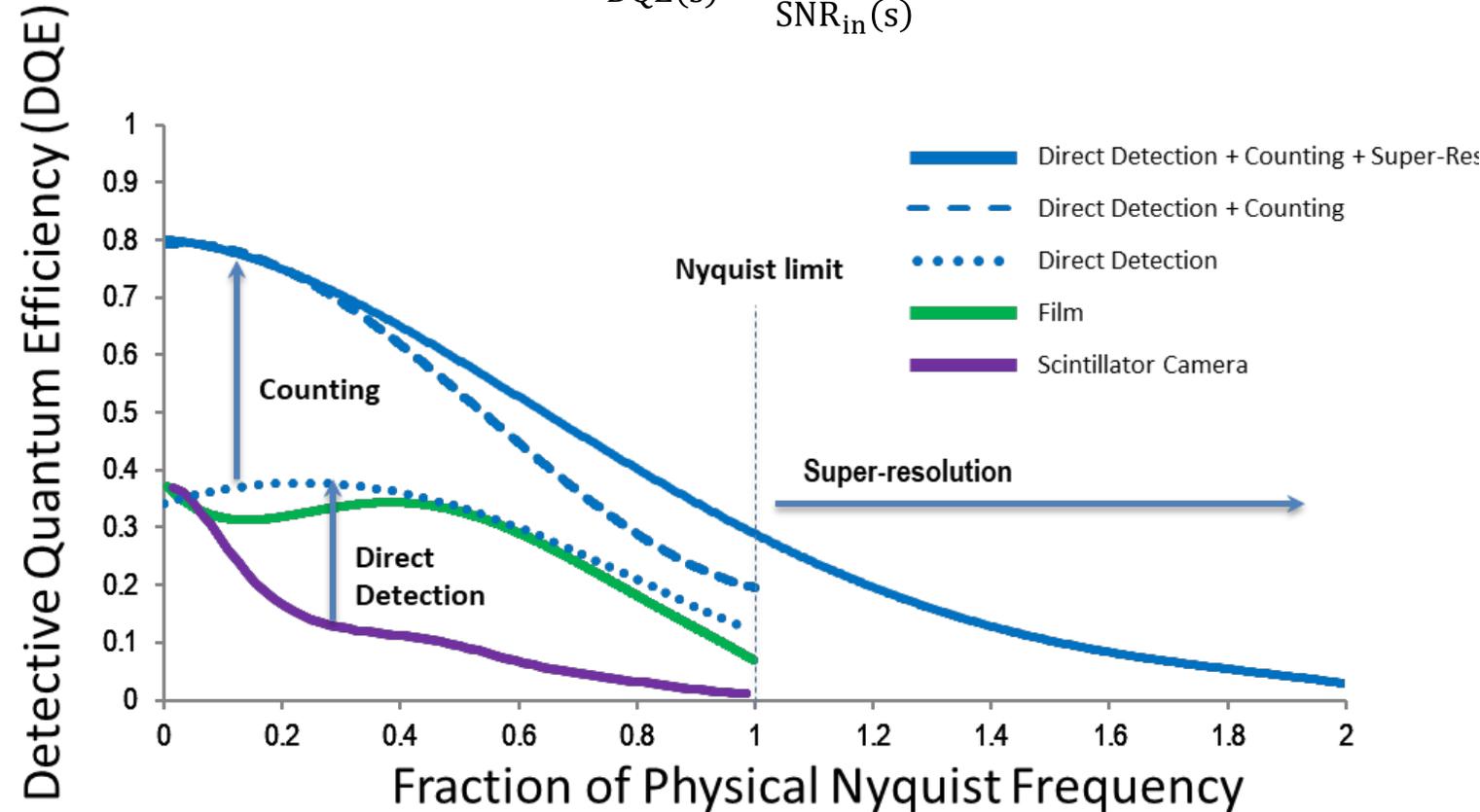


# Electron Counting in a Direct Electron Detector

- Each electron strikes the sensor creating a cloud of charge that spans a few pixels
- The charge is collected in each pixel
- a complex “centroiding” algorithm reduces the multi-pixel charge to a single pixel



$$DQE(s) = \frac{SNR_{out}(s)}{SNR_{in}(s)}$$



# Direct Detectors in the EPIC-TEM Facility

## JEOL ARM200CF (S)TEM



- 200 kV/80 kV/60 kV
- Aberration corrected (probe)
- 0.08 nm STEM resolution
- 0.23 nm TEM resolution
- 0.35 eV energy resolution
- Dual SDD EDS detector (1.7sr)
- Simultaneous HAADF/BF/ABF
- **Gatan Quantum Dual EELS (Updated with K2 direct camera)**
- AXON drift-correction software

## K2 IS



- 4k by 4k electron counting camera
- max. 1600 frames per second
- K2 direct detection sensor
- Dose fractionation mode for beam sensitive materials
- Quantum GIF + K2 leverages the counting capabilities of the K2 camera (EELS acquisition)

## GIF Quantum K2



## GIF Continuum K3 with Stela



## JEOL JEM-ARM300F (S)TEM



- 300 kV/80 kV/60 kV/40 kV
- 0.22 nm TEM / 0.19 nm STEM resolution
- **K3 IS DED (Gatan)**
- **Stela Hybrid-Pixel DED (Gatan)**
- **Updated with GIF Continuum (Gatan)**
- 0.29 eV energy resolution (300 kV)
- Simultaneous imaging by HAADF/BF/ABF
- SDD holder / delivery system
- Wide gap pole-EDS detector
- Hummingbird gas piece allows for wide variety of *in situ* experiments (heating, liquid, biasing, mechanical...)
- AXON drift-correction software

## K3 IS



- The world's first counting, high-speed, large format cameras for *in-situ* microscopy
- Large (3456 x 3456) field of view
- max. 3000 frames per second
- Synchronize frames for 4D STEM applications via STEMx

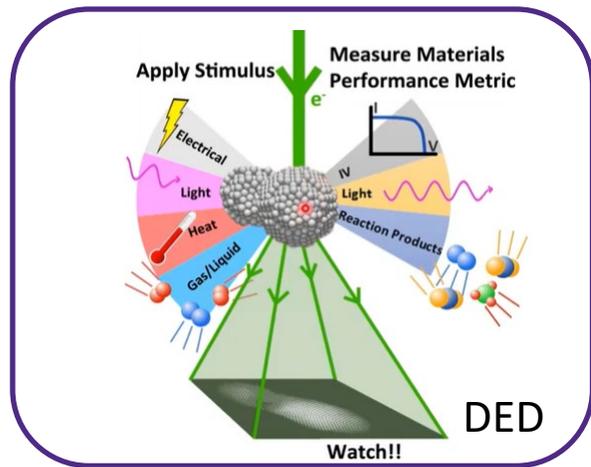
## Stela Hybrid-Pixel camera



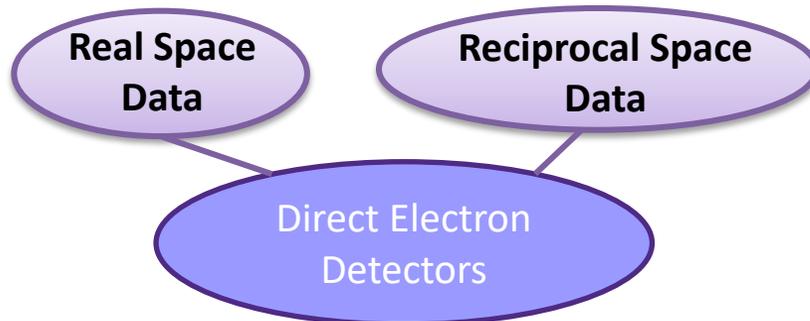
- **Hybrid-Pixel counting camera**
- 4D-STEM & diffraction imaging at low kV
- 512 x 512 pixels
- > 16,000 fps
- High dynamic range for weak reflections

# (S)TEM Techniques Benefiting from Direct Electron Detectors

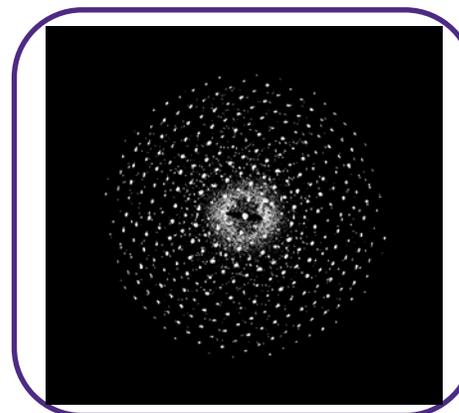
## (in situ) TEM Imaging



**Applications:** direct visualization of biasing, heating, liquid, liquid He effects

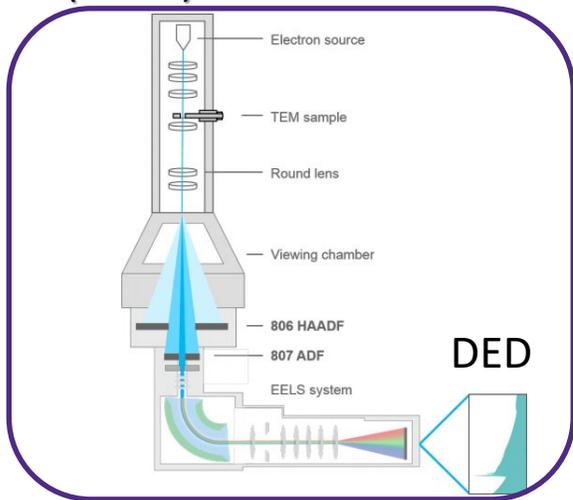


## (Selected Area) Diffraction, CBED & MicroED



**Applications:** (3D) crystal structure, Single CBED to measure specimen thickness, lattice strain measurements, point and space group determination, phonon structure, structure factor and charge density, etc.

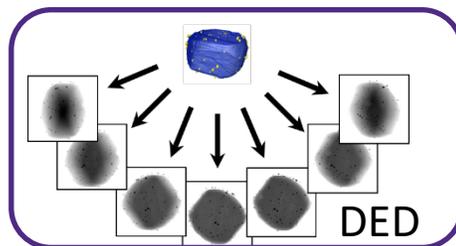
## (in situ) EELS and EFTEM



**Applications:**

EELS measurement	Information obtainable
Low-loss intensity	Local thickness, mass thickness
Plasmon energy	Valence-electron density
Plasmon peak shift	Alloy composition
Low-loss fine structure	Dielectric function, JDOS
Low-loss fingerprinting	Phase identification
Core-loss intensities	Elemental analysis
Orientation dependence	Atomic site location
Near-edge fine structure	Bonding information
Chemical shift of edges	Oxidation state, valency
$L$ or $M$ white-line ratio	Valency, magnetic properties
Extended fine structure	Interatomic distances
Bethe ridge (ECOSS)	Bonding information

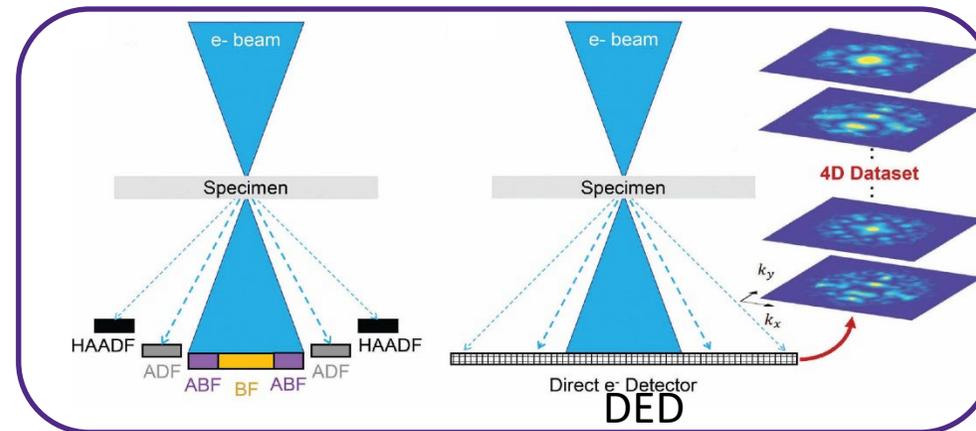
## Electron Tomography, SPA, Holography, etc.



**Applications:** 3D visualization

Electric/magnetic field imaging, thickness, etc.

## (in situ) 4D-STEM



**Applications:** Virtual imaging, Orientation mapping, Strain mapping, Electric/magnetic field mapping, Phase Contrast Imaging (DPC, Ptychography), Fluctuation electron microscopy (medium-range ordering), Pair Distribution Function Mapping (short-medium range ordering etc.)

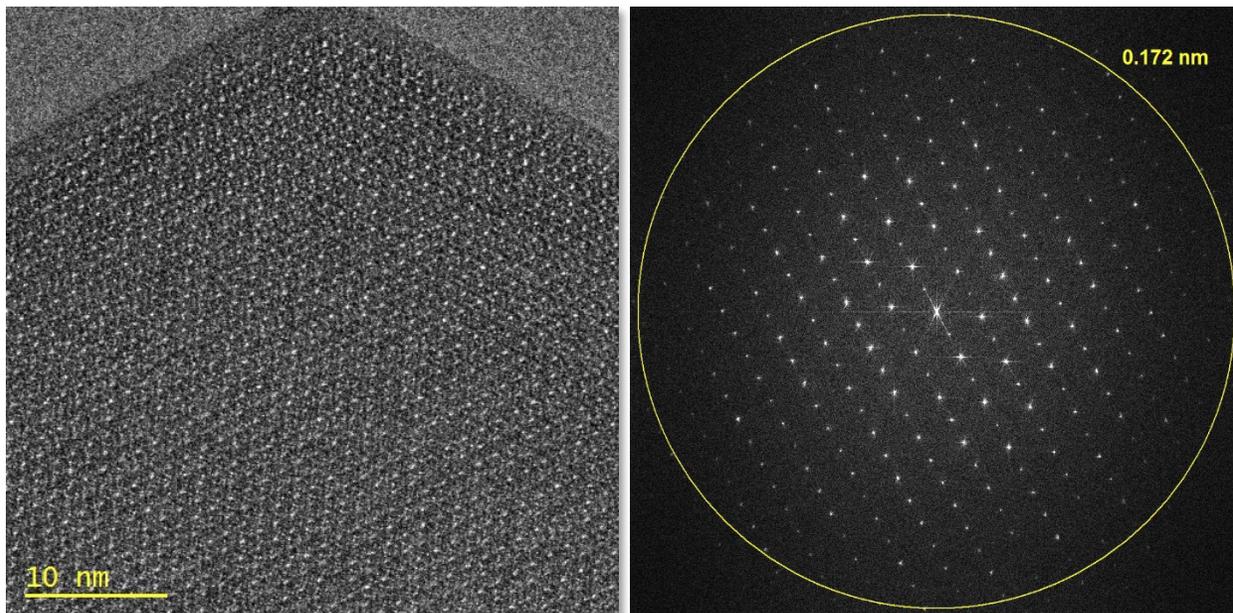
# DED advantage for Real Space Data Acquisition

- Examples using K3 IS



# TEM Imaging

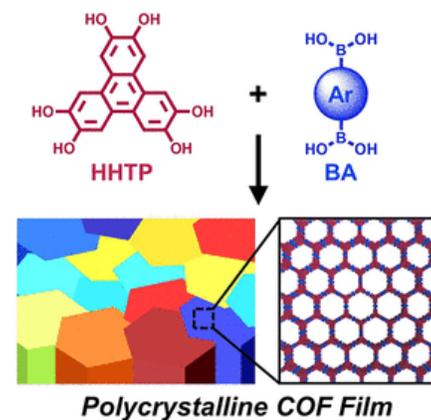
## Zeolite



$0.74 \text{ e}^- \text{ \AA}^{-2} \text{ s}^{-1}$  Dose Rate  
 $25 \text{ e}^- \text{ \AA}^{-2}$  Total Dose

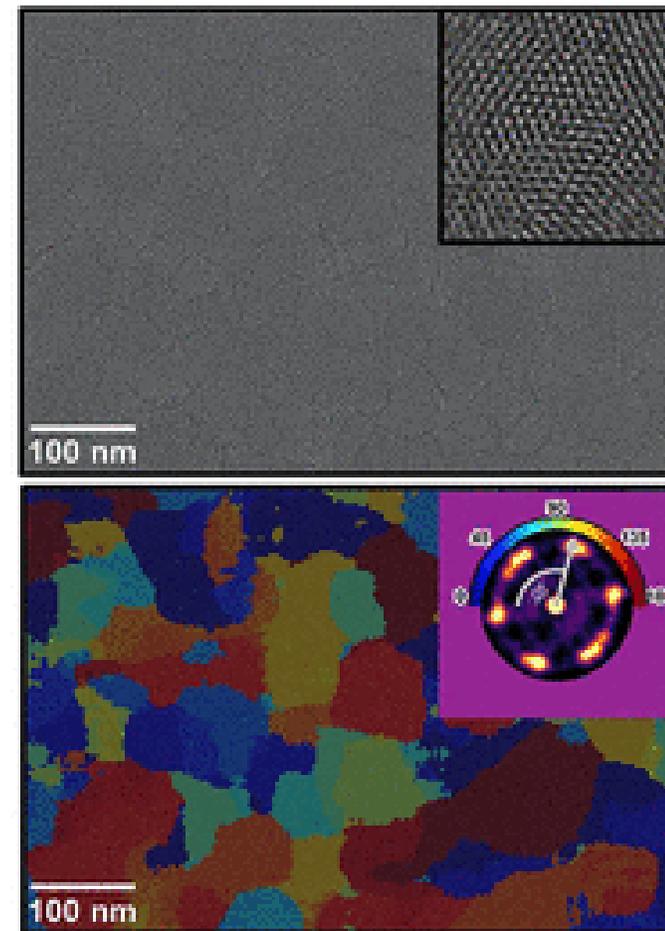
Counting individual electrons allows you to collect high-quality images at even lower doses and dose rates

## Covalent Organic Frameworks (COFs)

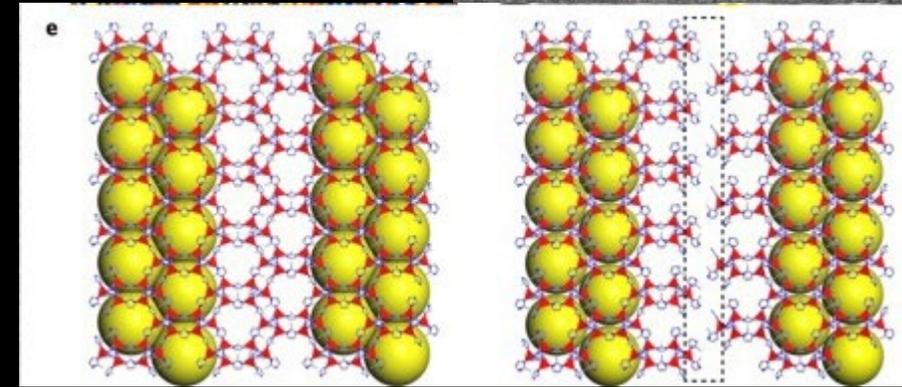
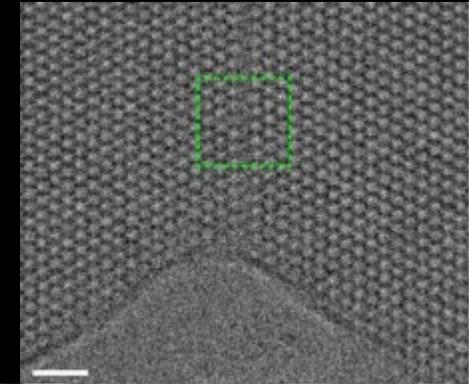
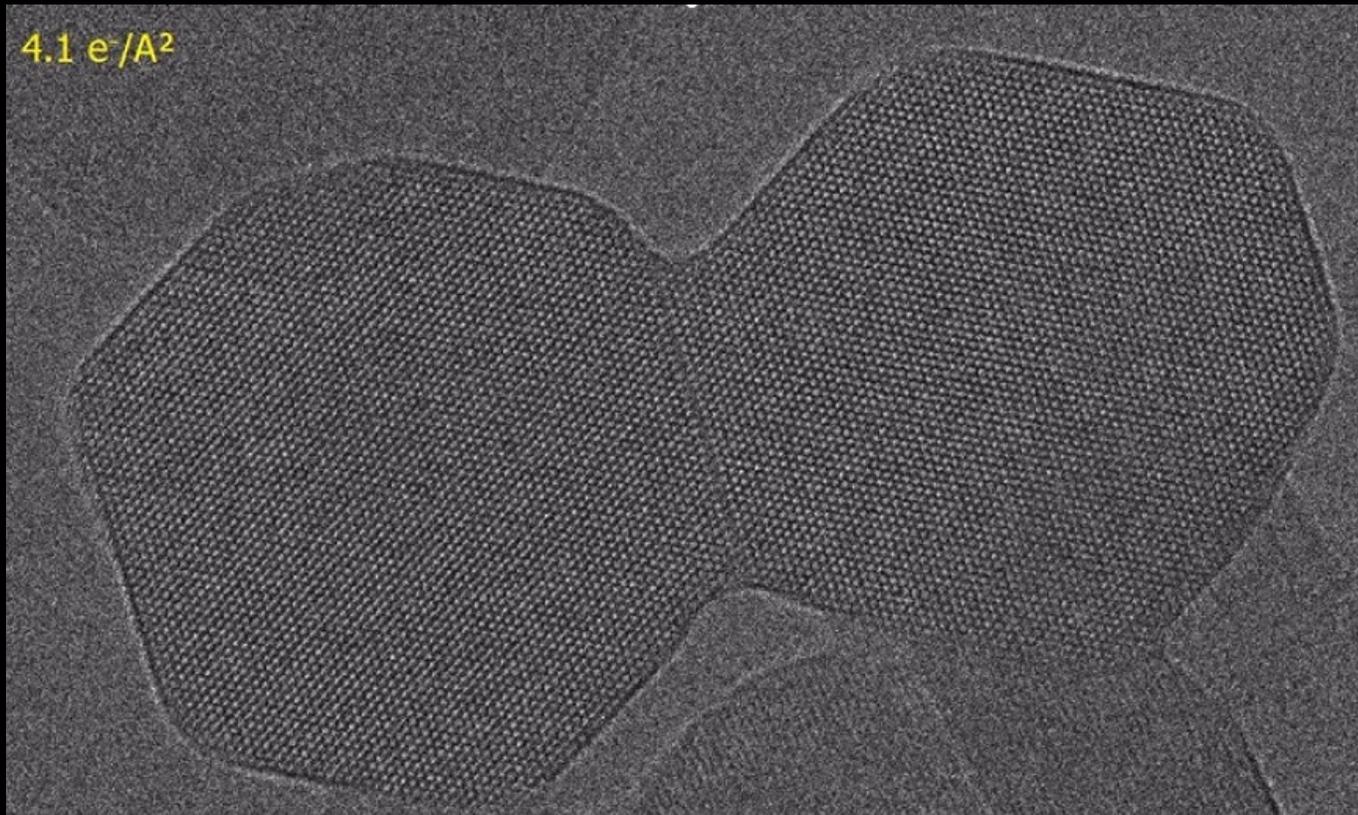


$2.1 \text{ e}^- \text{ \AA}^{-2} \text{ s}^{-1}$  Dose Rate  
 $14 \text{ e}^- \text{ \AA}^{-2}$  Total Dose

*I. Castano, A. M. Evans, R. dos Reis, V. P. Dravid, N. C. Gianneschi, and W. R. Dichtel. Chemistry of Materials 2021 33 (4), 1341-1352*



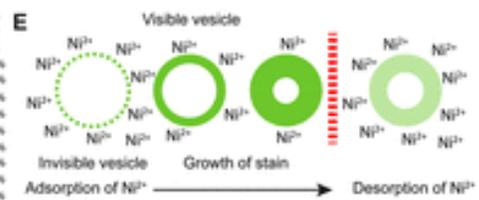
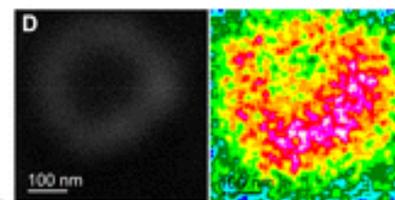
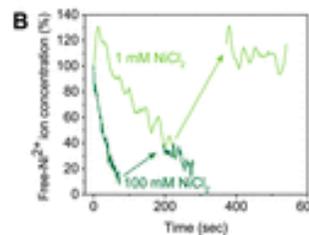
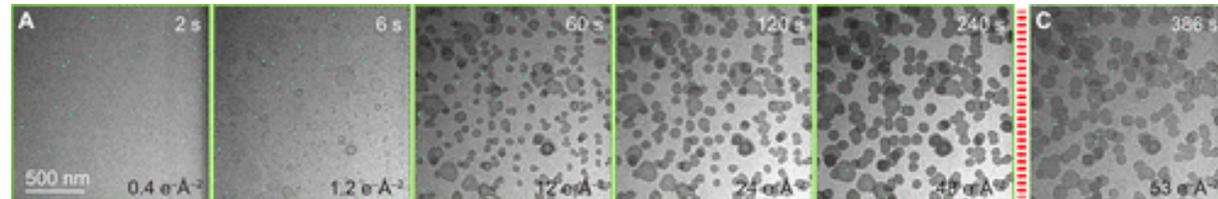
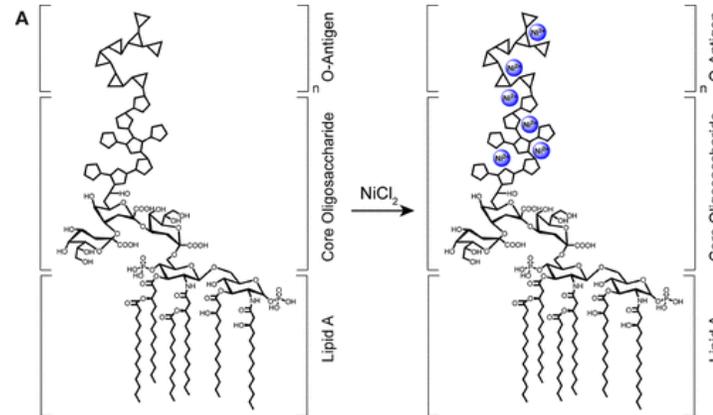
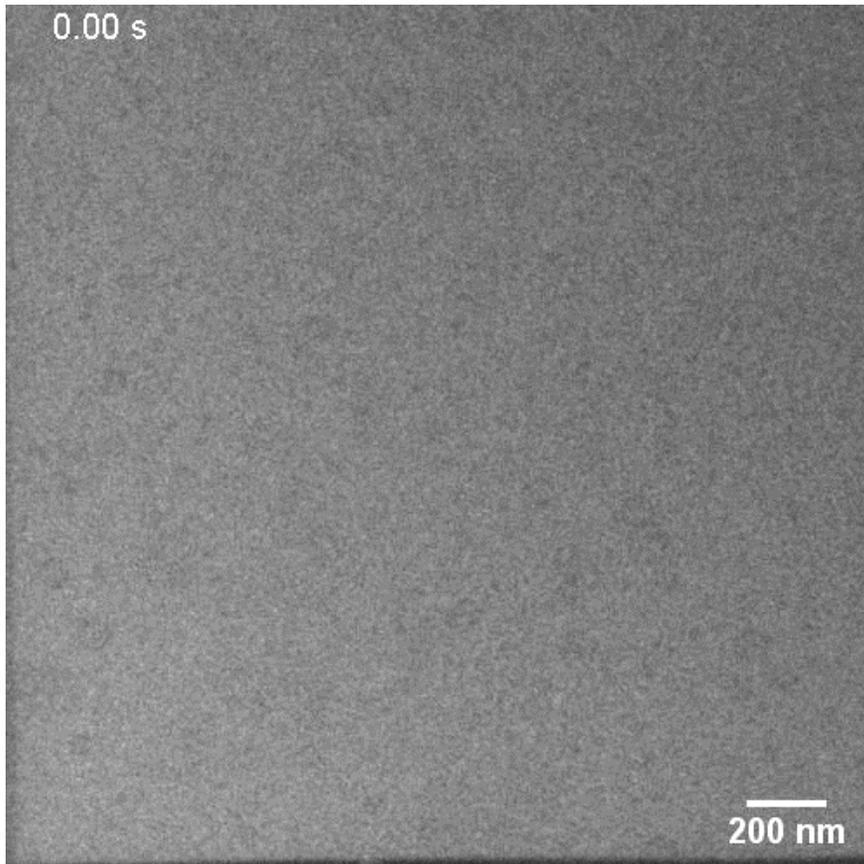
# TEM Imaging – Ultralow Dose MOF



TEM reveals important local structural features of ZIF-8 crystals that cannot be identified by diffraction techniques, including **armchair-type surface terminations** and **coherent interfaces** between assembled crystals

ZIF-8 MOF Dose Rate: 1.02 e/pix/s; pixel 0.86 nm; 120 frames  
Zhu, Y. *et al. Nature Materials* **16**, 532–536 (2017)

# In situ TEM – In Situ Staining Liposome

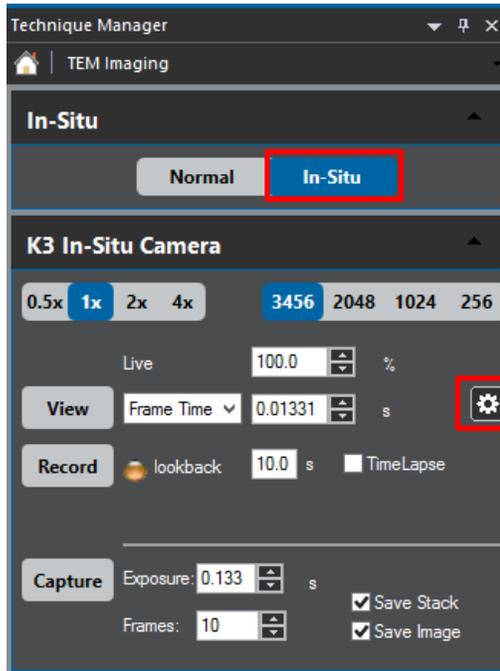


**K3 IS – 300kV**

Dose rate  $0.2 \text{ e}^- \text{ \AA}^{-2} \text{ s}^{-1}$

K. Gnanasekaran, B. Chang, P. Smeets, N. Gianneschi, *Nano Lett.* **2020**, 20, 6, 4292–4297

# *In situ* TEM – ARM300F (K3 IS)

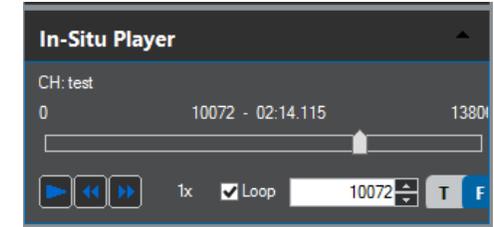


## *In situ* TEM Data Acquisition

- Binning, camera size
- Frame time (max. 75 fps full-frame)
- **Lookback:** save to disk x s before any dynamic event

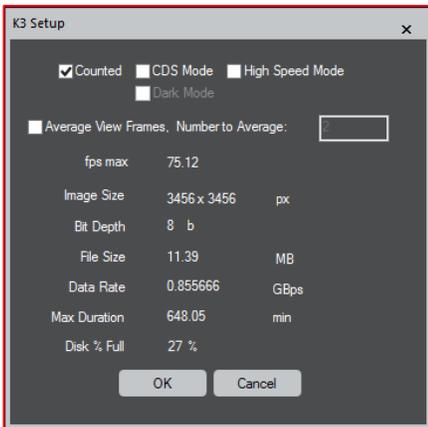
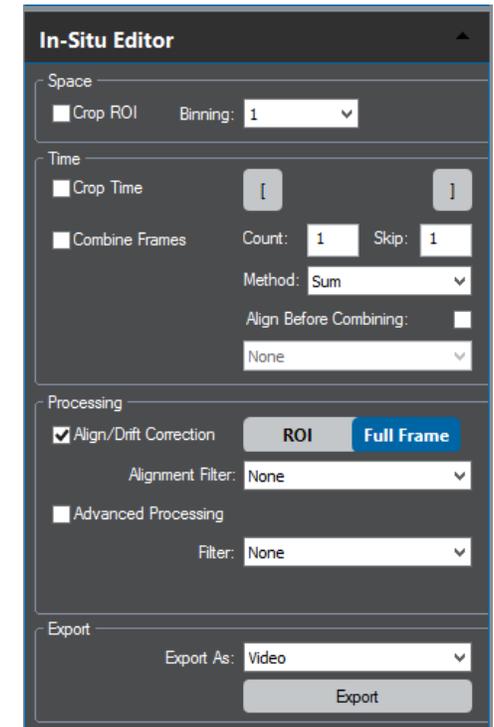
## *In situ* TEM Data Player

- Amount of frames / time
- Change playback speed



## *In situ* TEM Data Editor

- Cropping / frame averaging
- Drift correction using image registration (using imaging filters)
- Imaging filters
- Exporting video (adding scalebar, timestamp)

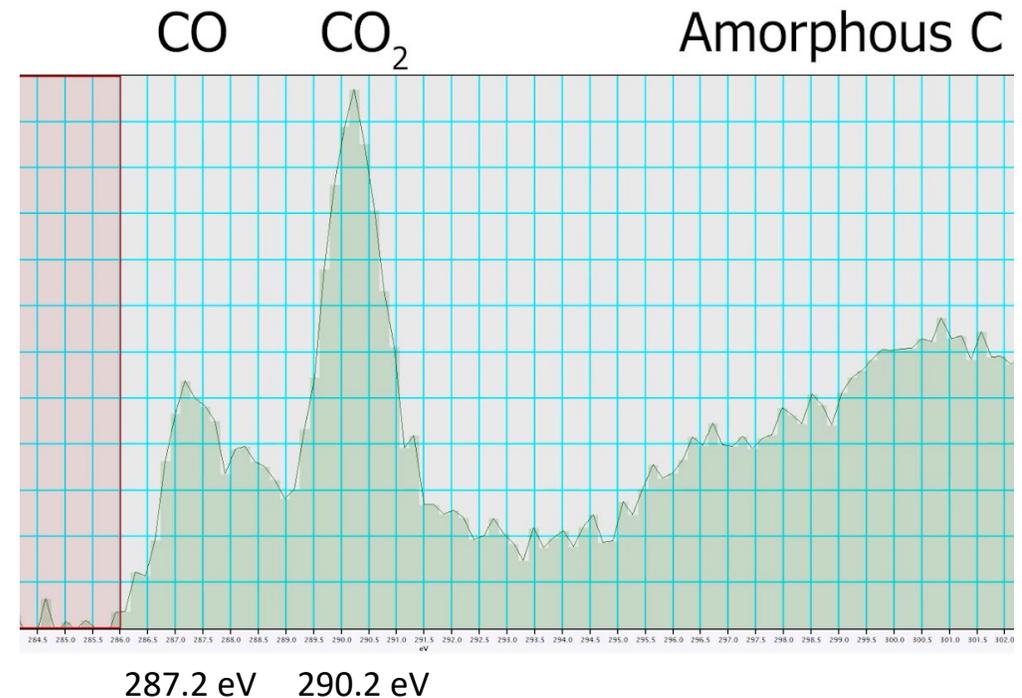


# In Situ EELS

- *In situ* EELS showing the interaction between electron beam and gas molecules

## Protochips Atmosphere 210 System attached on ARM 200CF

- Pressure range: 760 Torr (101.3 kPa) to 1 Torr (0.13 kPa);
- Flow range: 0.005 sccm to 1 sccm (ml/min);
- Temperature range: RT to 1000 °C with max 10 °C/s heating rate;
- Gas mixing: 0.01%-99.99% mixture of up to 3 non-corrosive gases;
- Vapor allowable: water, methanol, ethanol, hexane, naphtha, etc;
- Reaction gas Analyzer (RGA) attached



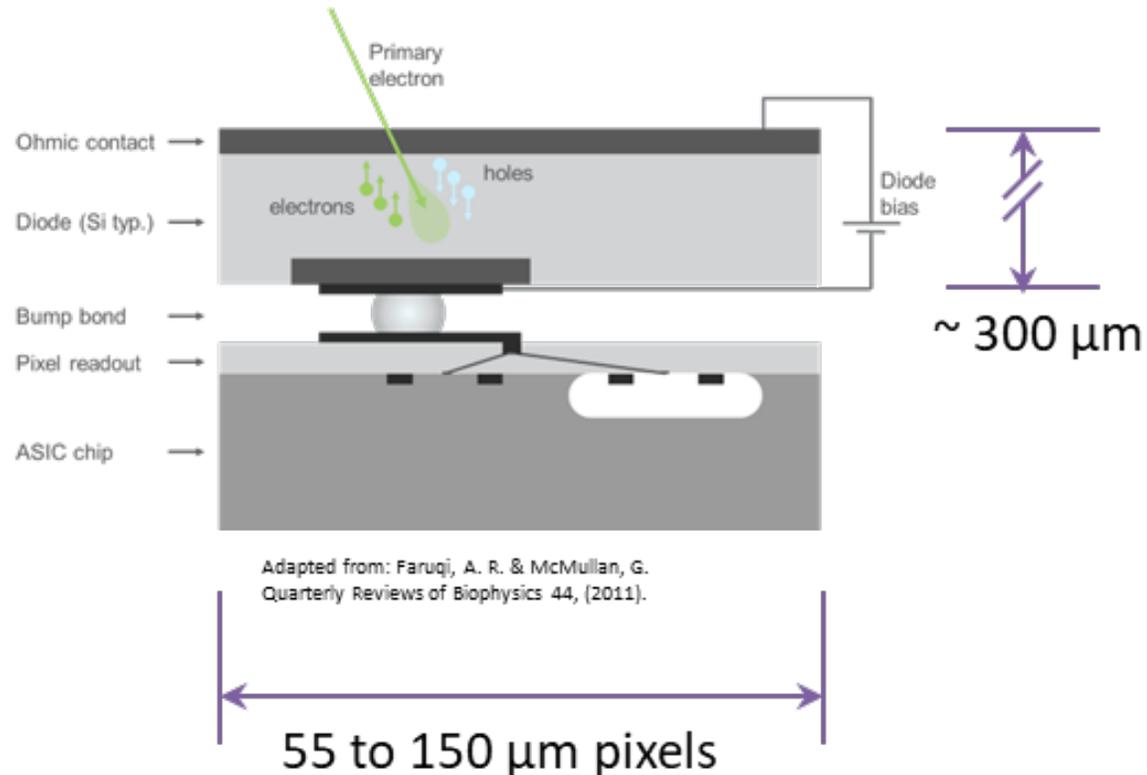
*Drs. Kunmo Koo & Xiaobing Hu, in prep.*

# DED advantage for Reciprocal Space Data Acquisition

- Examples using Stela Hybrid-Pixel Detector



# Stela Hybrid-Pixel Direct Detector (ARM300F)



## Advantages

- Fast readout, with direct digitization
- Near zero read noise enables multi-pass frame summing
- Broad range of input count rates (high dynamic range; works also well at higher dose rates)
- **Very sharp PSF at lower kVs**

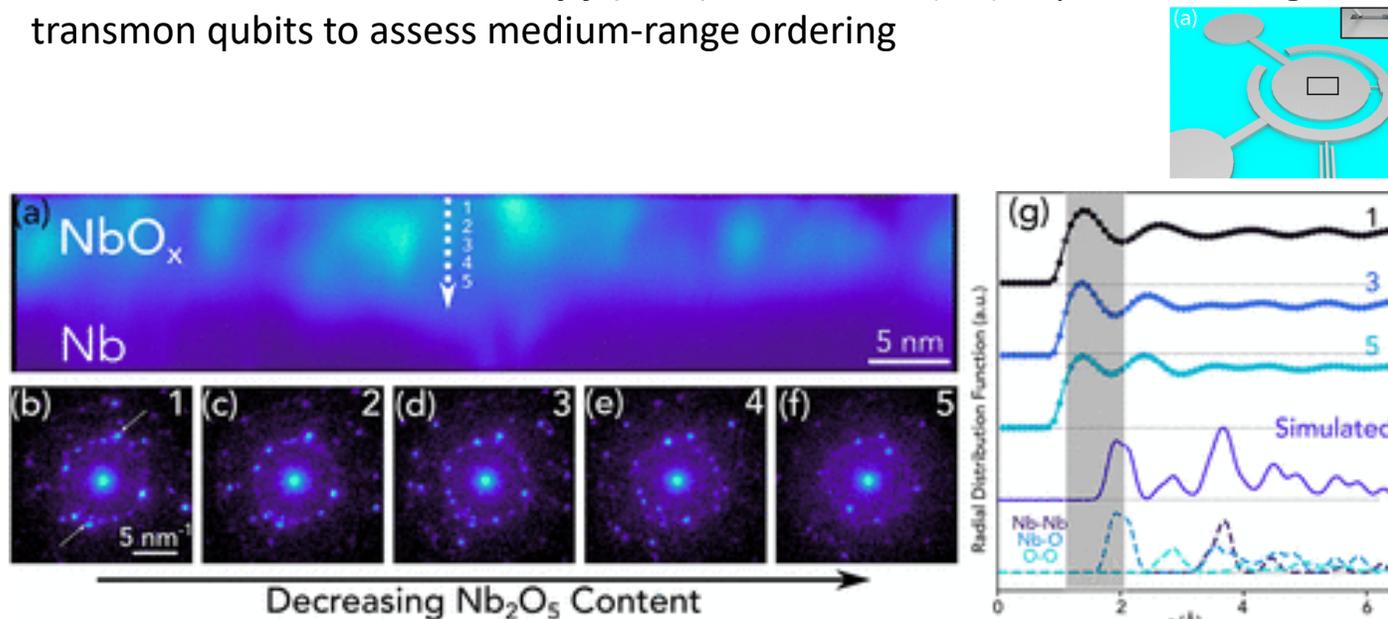
## Limitations

- Physically large, small number of pixels
- Poor PSF at high kVs

**Ideal for diffraction applications!**

# 4D-STEM

Fluctuation Electron Microscopy (FEM) on niobium (Nb)-superconducting transmon qubits to assess medium-range ordering



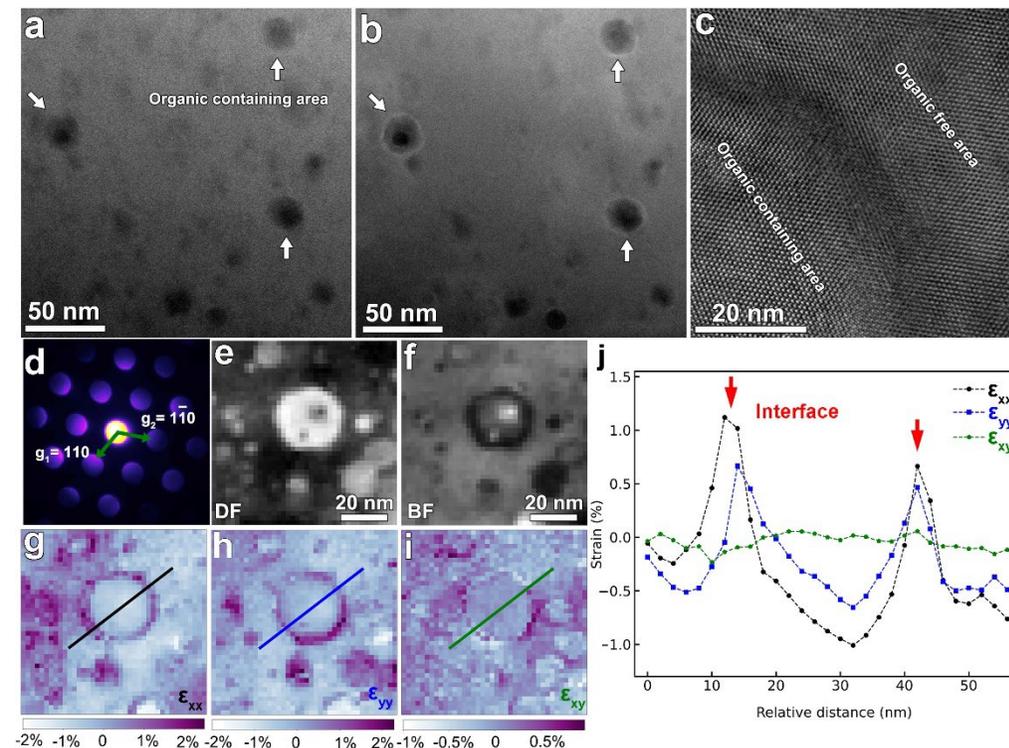
Structure factor  $S(Q)$

$$S(Q) - 1 = \frac{I(Q) - A(Q)}{B(Q)}$$

RDF

$$g(r) = 1 + \frac{1}{2\pi^2 \rho_0 r} \int_0^\infty Q [S(Q) - 1] \times \sin(Qr) dQ$$

Strain Analysis across soft-hard interface in nacre



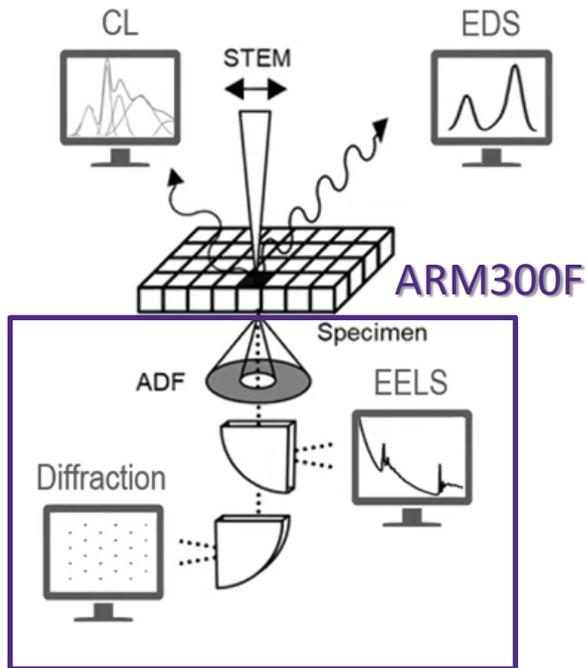
Drs. Xiaobing Hu & Paul Smeets, in prep.



Elucidating the Role of Nanoscale Organics in Natural Nanocomposite Materials, M&M 2023, Tuesday, 7/25 3-5pm

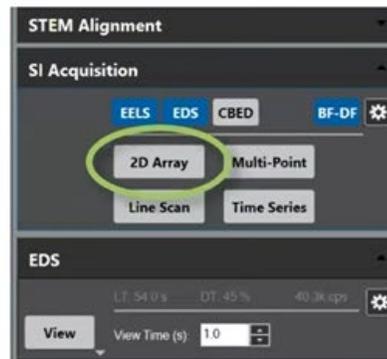
# (In Situ) 4D-STEM & EELS (Multimodal)

- On the **ARM300F** → EELS and 4D-STEM datasets from the same region can be obtained (Multimodal)
- Various SI Acquisition within the same software platform
- One sample, one microscope session, one data format



Multidimensional Electron Microscopy in the STEM: Scanning Diffraction and EELS Workshop

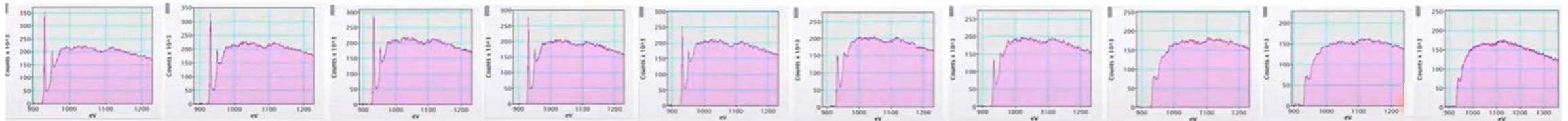
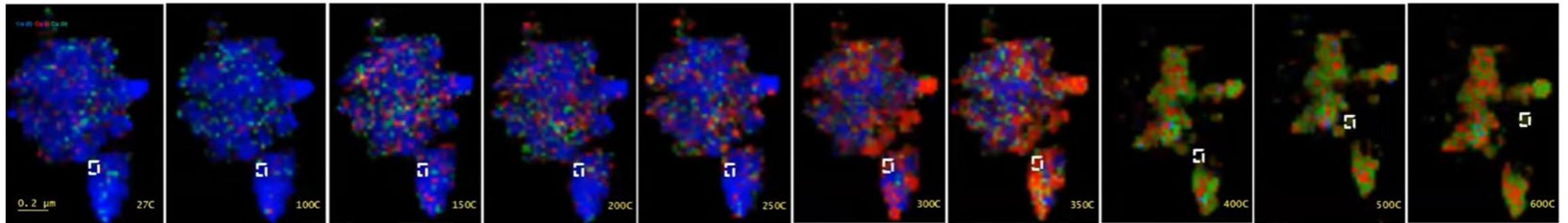
<https://www.youtube.com/watch?v=I2G1-t6bKKo>



# In Situ 4D-STEM & EELS (Multimodal)

- Heating experiment of  $\text{Fe}_2\text{O}_3 \cdot \text{H}_2\text{O}$  nanoparticles
- Cu(II) reduces to Cu(0) with temperature (EELS), crystal structure change from monoclinic to hexagonal

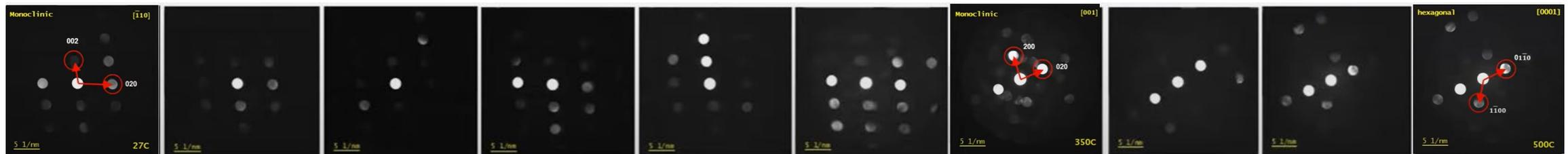
Temperature



Cu(II)

Cu(I)

Cu(0)



monoclinic

monoclinic

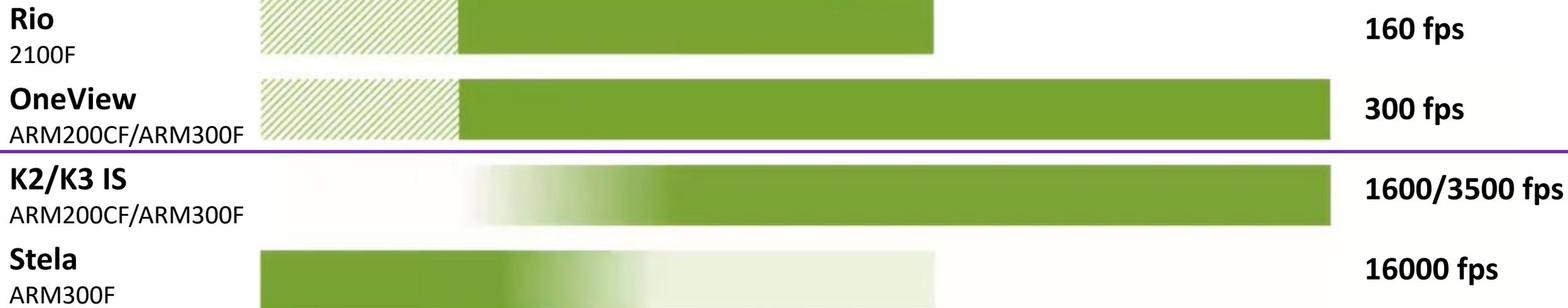
hexagonal

# Detector Performance



## Camera

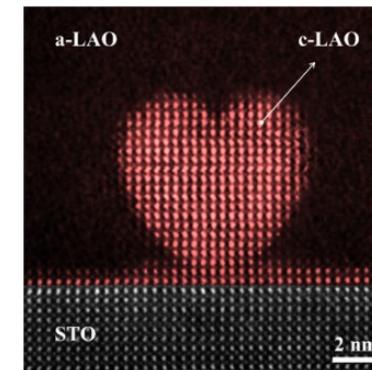
## Max. Framerate



# DED Matchmaker for the ARM300F

(S)TEM Technique	K3	Stela
EELS Mapping	Yes	No
Low-kV EELS	No	Yes
EFTEM imaging	Yes	No
Low-dose imaging	Yes	No
<i>In-situ</i> EFTEM	Yes	No
<i>In-situ</i> EELS	Yes	Yes
4D STEM / micro-ED	Yes	Yes

- **Stela** – High speed and high dynamic range ideal for diffraction imaging at low kV
- **K3** – High sensitivity, large pixel count ideal for low-dose imaging and *in-situ* studies



# Just Installed on the JEOL ARM200CF...



Ideal for 4D-STEM applications

Number of pixels (W x H) 192 x 192

Active area (W x H) [mm<sup>2</sup>] 20 x 20

Pixel size (W x H) [μm<sup>2</sup>] 100 x 100

Sensor material Silicon (Si) or high-Z

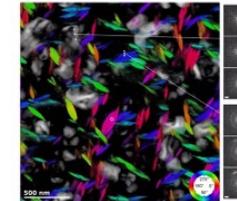
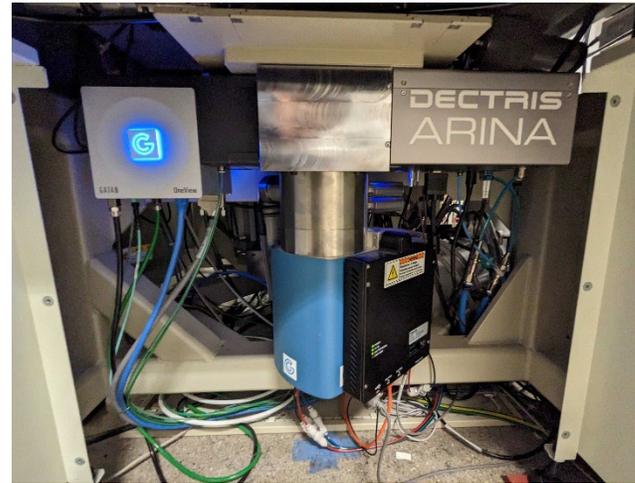
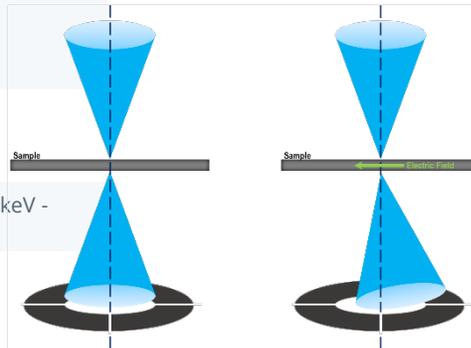
Energy range [keV] 30 - 300

Frame rate (max.) [Hz] **120,000**

Count rate (max.) [el/s/pixel] 10<sup>8</sup>

Detective Quantum Efficiency, DQE(0) at 80 keV - 0.82 | at 200 keV - 0.75 | at 300 keV - 0.75

Detector mounting Retractable

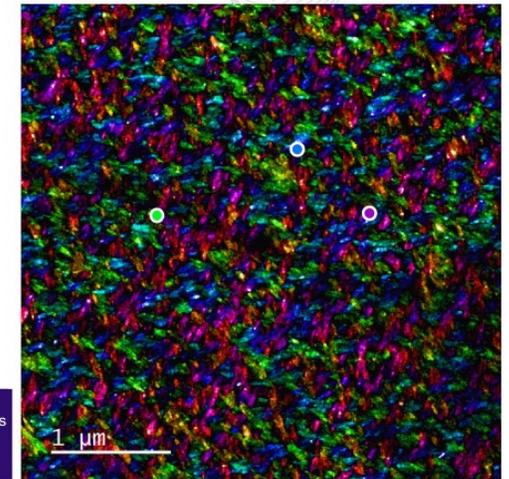
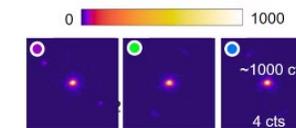


2021: 200x200 map ~ 2 min

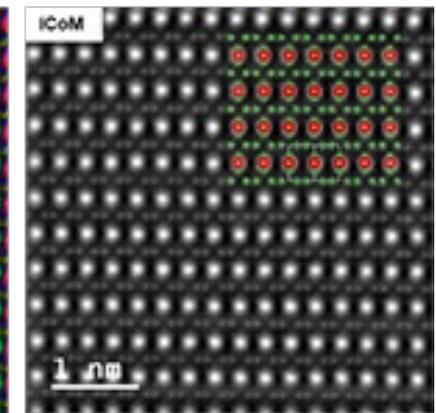
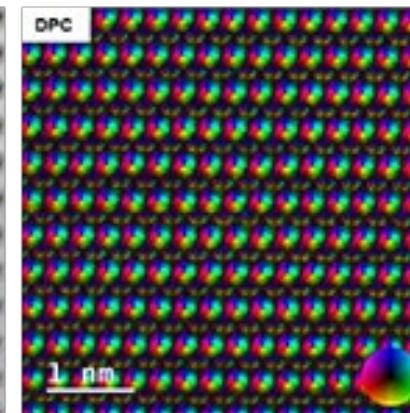
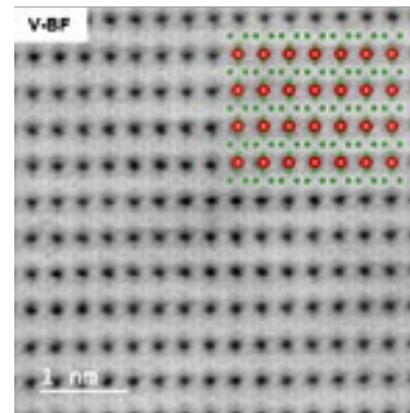
Ceta with speed upgrade: ~280 fps

Wu et. al., Nat. Commun. 13 (2022) 2911

2022: 1000x1000 map ~ 12 s



SmB<sub>6</sub>



# Contact Info



2145 Sheridan Road  
Tech Institute, AB Wing #AG96  
Evanston, Illinois 60208

[www.nuance.northwestern.edu](http://www.nuance.northwestern.edu)

## **Paul Smeets, PhD**

Research Assistant Professor  
TEM/FIB Manager

Email: [paul.smeets@northwestern.edu](mailto:paul.smeets@northwestern.edu)  
Phone: +1 (847) 491-7807